

Simulation of MgO/AA6061 Particulate-Reinforced Composites Taking Account of CTE Mismatch Effects and Interphase Separation

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Abstract: In the present work, the MgO/AA6061 alloy metal matrix composites were subjected to mechanical and thermal loads. The results obtained from the finite element analysis of MgO/AA6061 alloy composites reveal the interphase separation from the particle and the matrix. No particle fracture has been noticed in MgO/AA6061 composites.

Keywords: Magnesium oxide, AA6061 alloy, RVE model, finite element analysis, interphase separation.

1. INTRODUCTION

A major failure mode in composites is debonding, either between matrix and reinforcement. Debonding of particle/matrix interfaces in composites may significantly affect their macroscopic behavior since interface debonding leads to crack initiation and propagation. The unit cell methods can easily account for complex microstructural morphology and can enable the investigation of the influence of different geometrical features on the overall response. There are at least two interface properties that can influence the results. First, the interface plays a role in the ability of the matrix to transfer stress back into the broken particle in the metal matrix composites. Stress transfer needs to occur before more particle fractures take place. Second, the interface itself may fail. Stress transfer and interfacial failure are distinct properties of the interface. Finite element analysis for a unit cell containing one particle in a matrix was widely applied to fracture or debonding of particles [1]. In a series of research works carried out recently, the interface debonding was studied in composites subject to uniaxial tension since it is a widely used test to characterize the material behavior [2-15].

The aim of the present work is predict the influence of volume fraction and the mismatch of thermal expansion in magnesium oxide/AA6061 alloy composites on interphase separation and particle fracture. The shape magnesium oxide particle is spherical. The periodic particle distribution was a square array and corresponding representative volume element (RVE) is showed in figure 1.

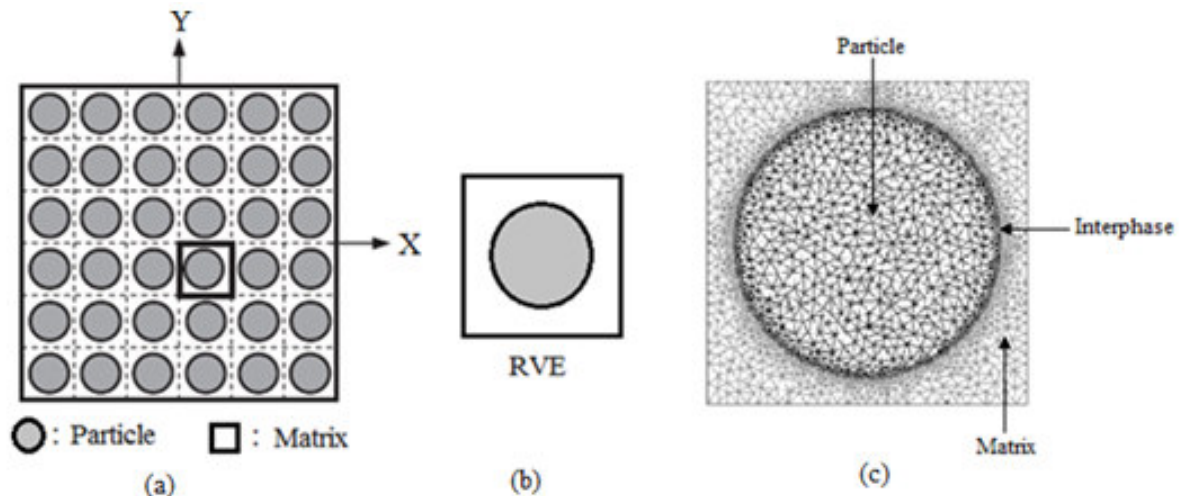


Figure 1: Square array of particles (a); Representative Volume Element (b); and Discretization of RVE (c).

2. MATERIALS METHODS

The matrix material was AA6061 alloy. The reinforcement material was magnesium oxide (MgO) nanoparticles of average size 100nm. The mechanical properties of materials used in the present work are given in table 1. In the current work, a cubical representative volume element (RVE) was implemented to analyze the tensile behavior MgO/AA6061 alloy composites at two (10% and 30%) volume fractions of MgO and at different temperatures. The large strain PLANE183 element was used in the

matrix in all the models. In order to model the adhesion between the matrix and the particle, a CONTACT 172 element was used.

Table 1: Mechanical properties of AA6061 matrix and MgO nanoparticles

Property	AA6061	MgO
Density, g/cc	2.70	3.54
Elastic modulus, GPa	68.9	270.0
Coefficient of thermal expansion, $10^{-6} 1/^{\circ}\text{C}$	23.6	12.0
Specific heat capacity, J/kg $^{\circ}\text{C}$	896	1030
Thermal conductivity, W/m $^{\circ}\text{C}$	167	60
Poisson's ratio	0.33	0.35

3. RESULTS AND DISCUSSION

The elastic moduli are normalized with the elastic modulus (E_m) of AA6061 alloy. The normalized elastic moduli, E_x/E_m and E_y/E_m , are decreased with increase of thermal loading (figure 2a). E_x/E_m is higher than E_y/E_m due to tensile loading along x-direction. The normalized shear modulus increases with increase of temperature as shown in figure 2b. The increase of major Poisson's ratio with increase of temperature from 100 $^{\circ}\text{C}$ to 300 $^{\circ}\text{C}$ indicates the elongation along the load is greater than that along the transverse direction of loading of RVE (figure 2c). The decrease of Poisson's ratio from 30 $^{\circ}\text{C}$ to 100 $^{\circ}\text{C}$ is not clear.

If the particle deforms in an elastic manner (according to Hooke's law) then,

$$\tau = \frac{n}{2} \sigma_p \quad (1)$$

where σ_p is the particle stress. For the interfacial debonding/yielding to occur, the interfacial shear stress reaches its shear strength:

$$\tau = \tau_{\max} \quad (2)$$

For particle/matrix interfacial debonding can occur if the following condition is satisfied:

$$\tau_{\max} < \frac{n\sigma_p}{2} \quad (3)$$

The interphase separation occurs between MgO nanoparticle and AA6061 alloy matrix as seen from figure 3 as the condition in Eq.(3) is satisfied. If particle fracture occurs when the stress in the particle reaches its ultimate tensile strength, $\sigma_{p,uts}$, then setting the boundary condition at

$$\sigma_p = \sigma_{p,uts} \quad (4)$$

The relationship between the strength of the particle and the interfacial shear stress is such that if

$$\sigma_{p,uts} < \frac{2\tau}{n} \quad (5)$$

Then the particle will fracture. From the figure 3b, it is observed that the MgO nanoparticle is not as the condition in Eq. (5) is not satisfied.

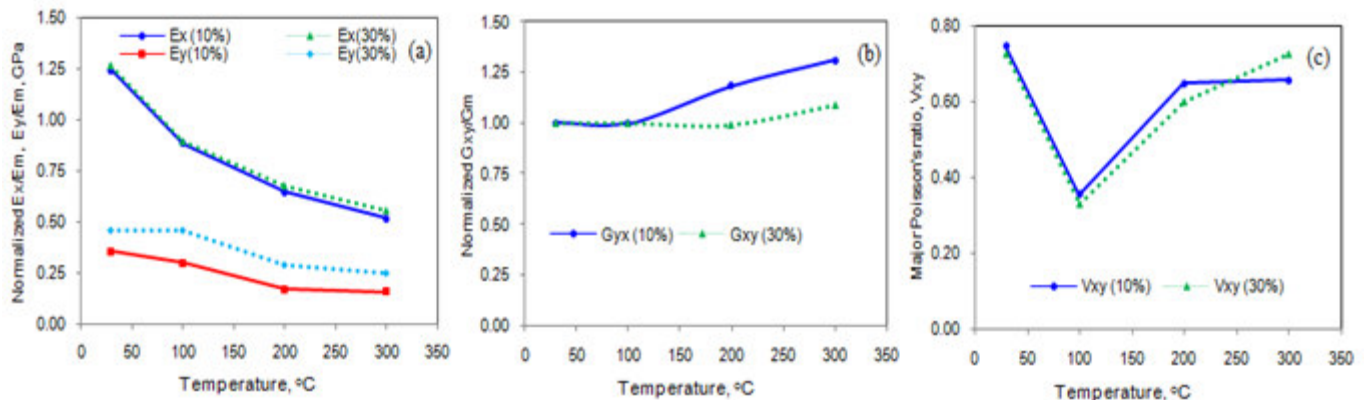


Figure 2: Effect of temperature on micromechanical properties of MgO/AA6061 composites.

The von Mises stress as a function of temperature is illustrated in figure 4. The von Mises stresses induced at the interface are higher than that induced in the nanoparticle. Hence, the interphase separation has occurred between the particle and the matrix.

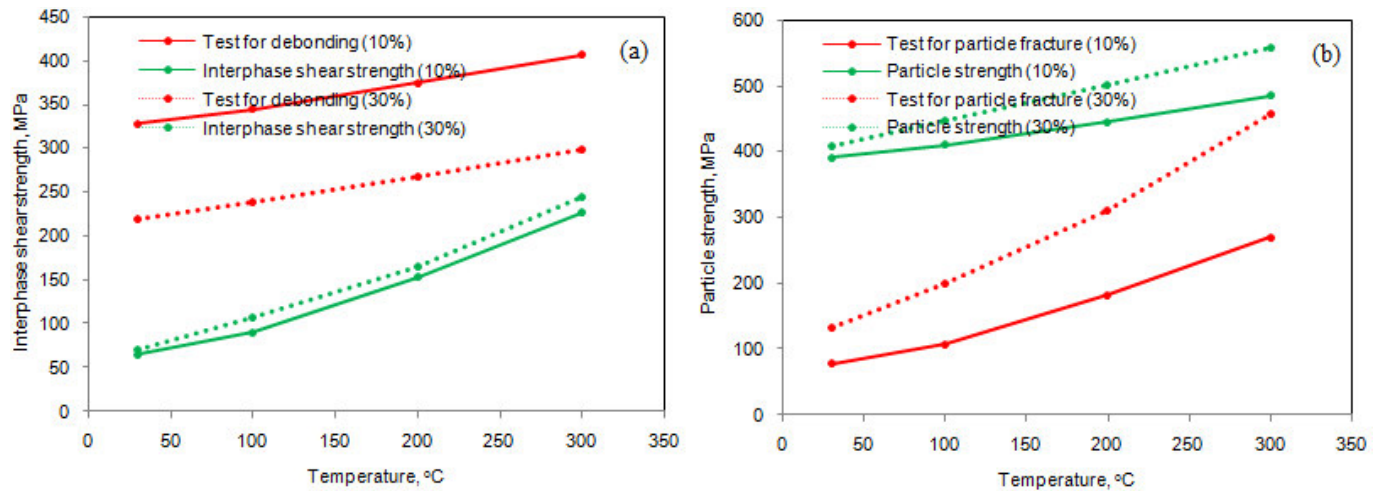


Figure 3: Criterion for interfacial debonding (a) and for particle fracture (b).

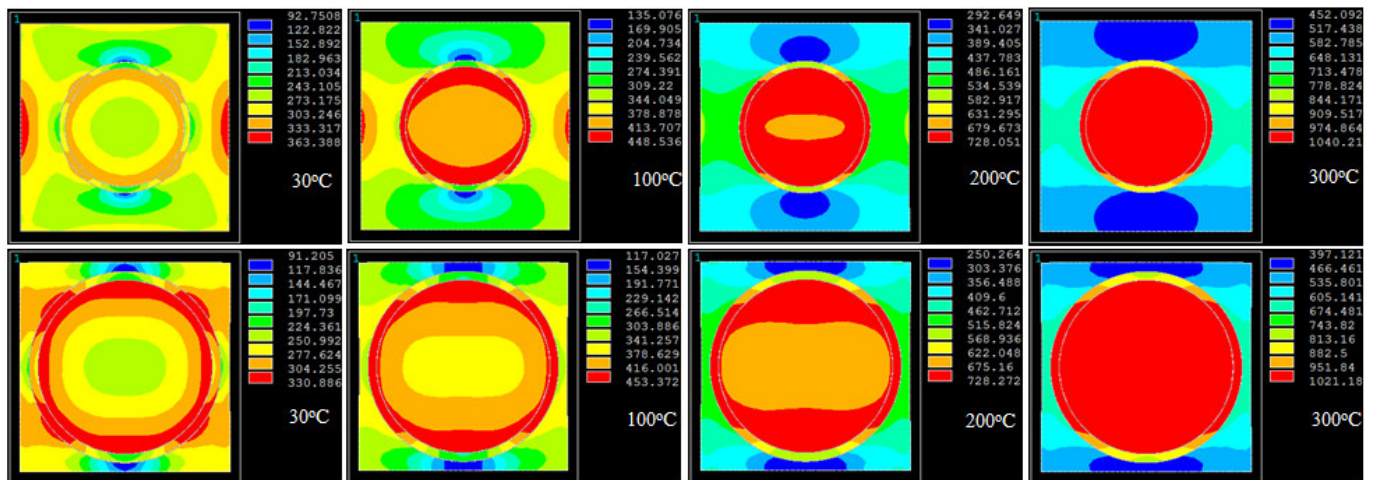


Figure 4: Images of von Mises stresses obtained from FEA: (a) 10% MgO/AA6061 alloy and (b) 30% MgO/AA6061 alloy composites.

4. CONCLUSION

The shear stress is high at the interface resulting to interphase separation from the particle and the matrix. The interphase separation has occurred between the particle and the matrix in MgO/AA6061 composites. The fracture of MgO particle was not observed.

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